Wood Adhesives Conference Announces Call for Papers

The 2017 International Conference on Wood Adhesives is pleased to announce a call for papers. This is the 11th in a series organized every four years by the U.S. Forest Service Forest Products Laboratory and Forest Products Society. The conference will be held Oct. 25-27, 2017, at the Sheraton Hotel in Atlanta. The conference will bring together industry, academics and consultants with a special interest in adhesives for wood and biomass.

Submissions can include the latest information on the following subject areas:

- Structure and properties of adhesive systems
- Bonding untraditional substrates
- New wood-based bonded products
- Bio-based and novel raw materials and adhesive systems, resin chemistry
- Issues with commercial implementation of new adhesives
- Impact of regulations and consumer preference
- Fundamental understanding of wood bonding and adhesive-substrate interactions
- Composites
- Modeling
- Engineered wood
- Analytical and testing methodology
- Energy concerns and opportunities
- Other applications

Abstracts should be 250 words or less and will be available via plenary, technical and poster presentations, tabletop exhibits and personal interactions with leaders in the field. Please indicate your preferred sessions (first and second choice). Abstracts should be submitted online to http://www.forestprod.org/woodadhesives/index-5-submit.html by April 1, 2017.

For more information on 2017 International Conference on Wood Adhesives, contact Scott Springmier, Executive Director at scott@forestprod.org, or visit http://www.forestprod.org/woodadhesives/.